

20V COMPLEMENTARY MEDIUM POWER TRANSISTOR IN SOT26

Features

- NPN + PNP combination
- $BV_{CEO} > 20$ (-20)V
- $BV_{EBO} > 7$ (-7)V
- Continuous Collector Current $I_C = 4$ (-3.5)A
- $V_{CE(sat)} < 50$ (-65)mV @ 1A
- $R_{CE(sat)} = 35$ (54)mΩ
- **Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Description

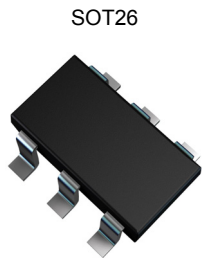
Advanced process capability has been used to achieve this high performance device. Combining NPN and PNP transistors in the SOT26 package provides a compact solution for the intended applications.

Mechanical Data

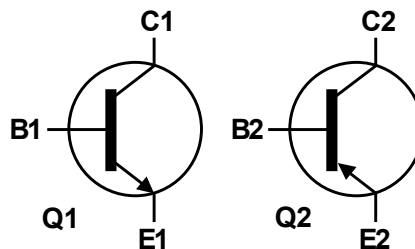
- Case: SOT26
- Case Material: molded plastic, "Green" molding compound
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 ③
- Weight: 0.015 grams (approximate)

Applications

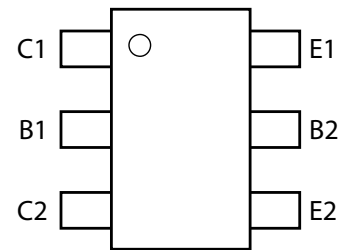
- MOSFET and IGBT gate driving
- Motor drive



Top View



Device Symbol



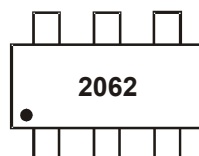
Top View
Pin-Out

Ordering Information (Note 4)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTC2062E6TA	2062	7	8	3,000

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See <http://www.diodes.com/> for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.
 3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com>

Marking Information



2062 = Product Type Marking Code

Maximum Ratings – Q1 (NPN Transistor) (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	100	V
Collector-Emitter Voltage	V _{CEO}	20	V
Emitter-Collector Voltage (reverse blocking)	V _{ECO}	5	V
Emitter-Base Voltage	V _{EBO}	7	V
Continuous Collector Current	I _C	4	A
Peak Pulsed Collector Current	I _{CM}	10	A
Base Current	I _B	1	A

Maximum Ratings – Q2 (PNP Transistor) (@T_A = +25°C, unless otherwise specified.)

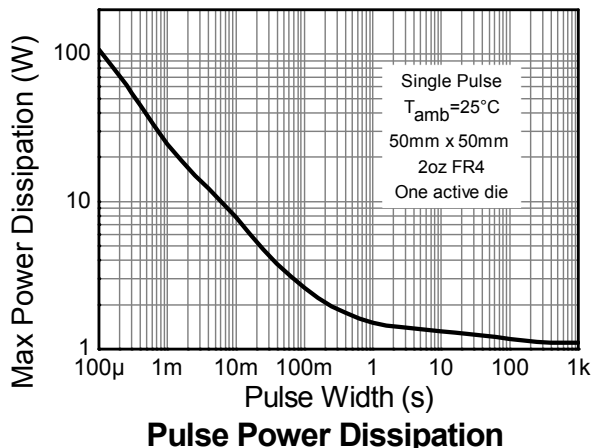
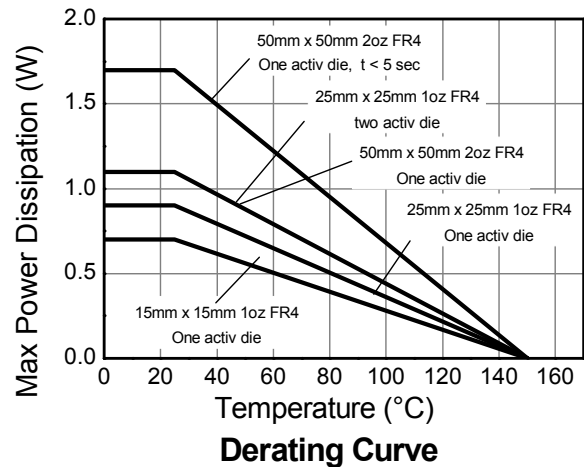
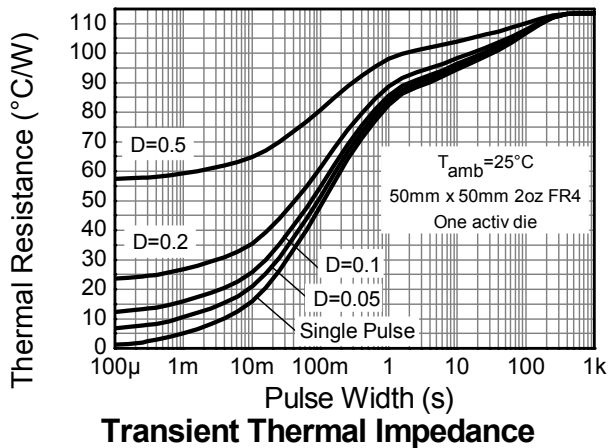
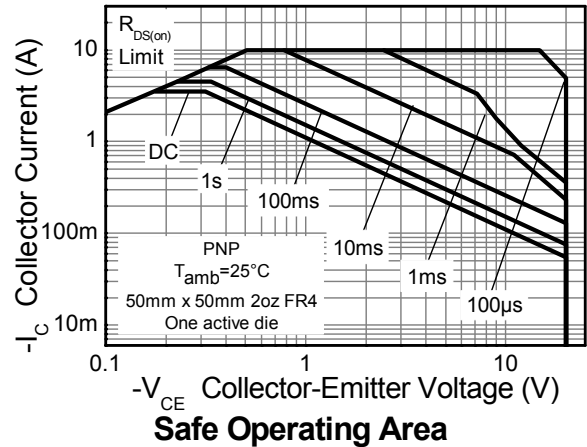
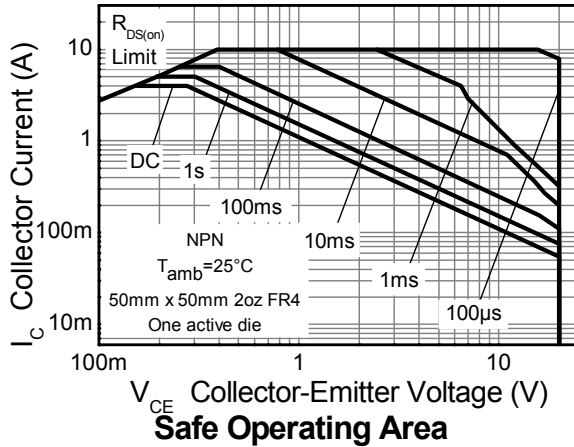
Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-25	V
Collector-Emitter Voltage	V _{CEO}	-20	V
Emitter-Collector Voltage (reverse blocking)	V _{ECO}	-4	V
Emitter-Base Voltage	V _{EBO}	-7	V
Continuous Collector Current	I _C	-3.5	A
Peak Pulsed Collector Current	I _{CM}	-10	A
Base Current	I _B	-1	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation Linear Derating Factor	P _D	0.7	W mW/°C
		5.6	
		0.9	
		7.2	
		1.1	
		8.8	
Thermal Resistance, Junction to Ambient	R _{θJA}	1.1	°C/W
		8.8	
		1.7	
		13.6	
		179	
Thermal Resistance, Junction to Ambient	R _{θJA}	139	°C/W
		113	
		113	
		73	
Thermal Resistance, Junction to Lead	R _{θJL}	87.58	
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

- Notes:
- For a device surface mounted on 15mm x 15mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
 - Same as note (5), except the device is surface mounted on 25mm x 25mm 1oz copper.
 - Same as note (5), except the device is surface mounted on 50mm x 50mm 2oz copper.
 - Same as note (7), except the device is measured at t < 5 seconds.
 - For device with one active die, both collectors attached to a common heatsink.
 - For device with two active dice running at equal power, split heatsink 50% to each collector.
 - Thermal resistance from junction to solder-point (at the end of the collector lead).

Thermal Characteristics and Derating Information



Electrical Characteristics – Q1 (NPN Transistor) (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BV_{CBO}	100	140	—	V	$I_C = 100\mu\text{A}, I_E = 0$
Collector-Emitter Breakdown Voltage (Note 12)	BV_{CEO}	20	35	—	V	$I_C = 10\text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	BV_{EBO}	7	8.3	—	V	$I_E = 100\mu\text{A}, I_C = 0$
Emitter-Collector breakdown voltage (base open)	BV_{ECO}	5	6	—	V	$I_E = 100\mu\text{A}$
Collector Cutoff Current	I_{CBO}	—	<1	50 0.5	nA μA	$V_{CB} = 100\text{V}$ $V_{CB} = 100\text{V}, T_A = +100^\circ\text{C}$
Collector Cutoff Current	I_{EBO}	—	<1	50	nA	$V_{EB} = 5.6\text{V}$
ON CHARACTERISTICS (Note 12)						
DC Current Gain	h_{FE}	300 280 140 —	450 420 210 15	900 — — —	—	$I_C = 10\text{mA}, V_{CE} = 2\text{V}$ $I_C = 1\text{A}, V_{CE} = 2\text{V}$ $I_C = 4\text{A}, V_{CE} = 2\text{V}$ $I_C = 15\text{A}, V_{CE} = 2\text{V}$
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	—	40 60 95 140	50 75 115 190	mV	$I_C = 1.0\text{A}, I_B = 100\text{mA}$ $I_C = 1.0\text{A}, I_B = 20\text{mA}$ $I_C = 2.0\text{A}, I_B = 40\text{mA}$ $I_C = 4\text{A}, I_B = 200\text{mA}$
Base-Emitter Saturation Voltage	$V_{BE(sat)}$	—	940	1050	mV	$I_C = 4\text{A}, I_B = 200\text{mA}$
Base-Emitter Turn-On Voltage	$V_{BE(on)}$	—	810	900	mV	$I_C = 4\text{A}, V_{CE} = 2\text{V}$
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	C_{obo}	—	17	25	pF	$V_{CB} = 10\text{V}, f = 1.0\text{MHz}$
Current Gain-Bandwidth Product	f_T	—	215	—	MHz	$V_{CE} = 10\text{V}, I_C = 50\text{mA}, f = 100\text{MHz}$
Delay Time	t_d	—	68	—	ns	$V_{CC} = 10\text{V}, I_C = 1\text{A}, I_{B1} = -I_{B2} = 10\text{mA}$
Rise Time	t_r	—	72	—	ns	
Storage Time	t_s	—	361	—	ns	
Fall Time	t_f	—	64	—	ns	

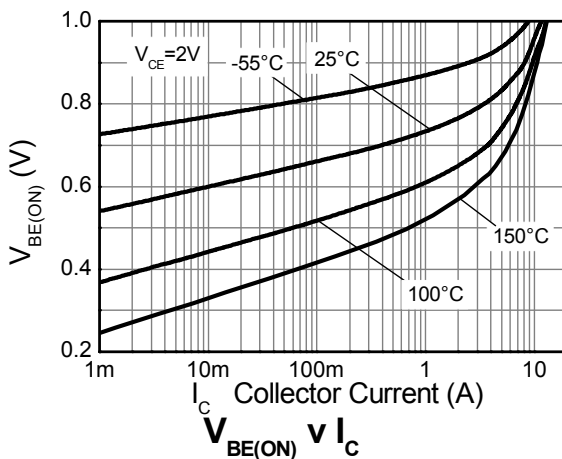
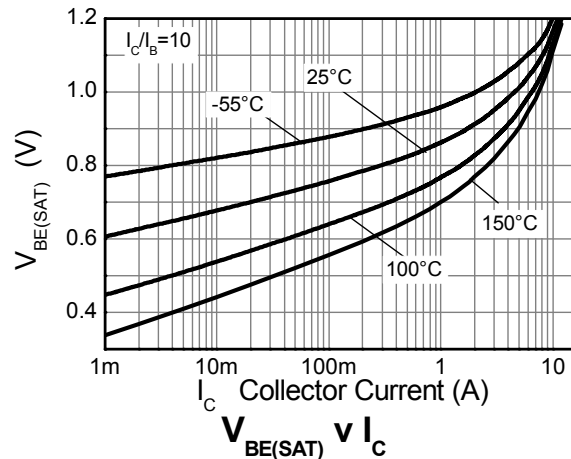
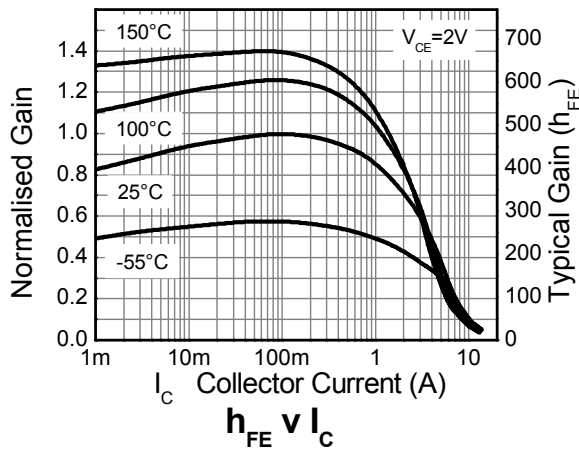
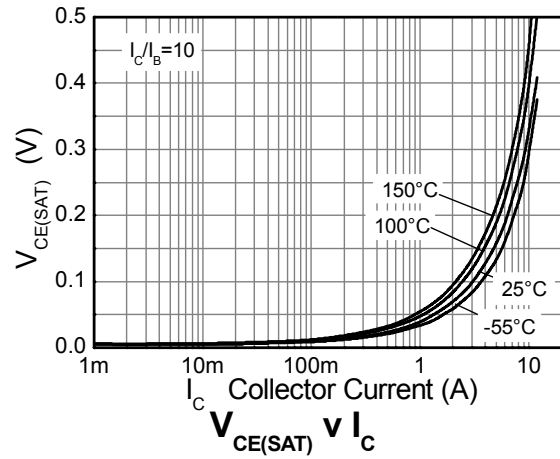
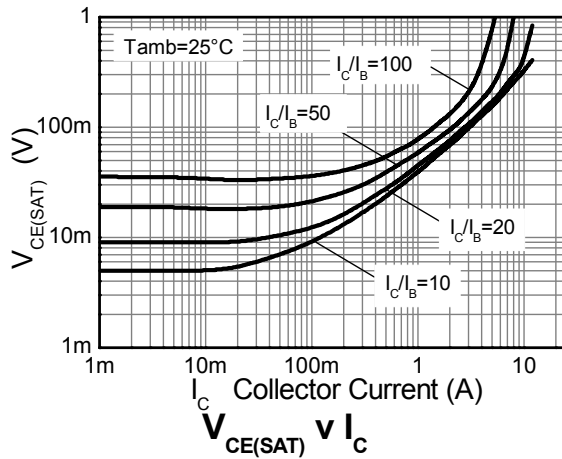
Notes: 12. Measured under pulsed conditions. Pulse width $\leq 300\mu\text{s}$. Duty cycle $\leq 2\%$.

Electrical Characteristics – Q2 (PNP Transistor) (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

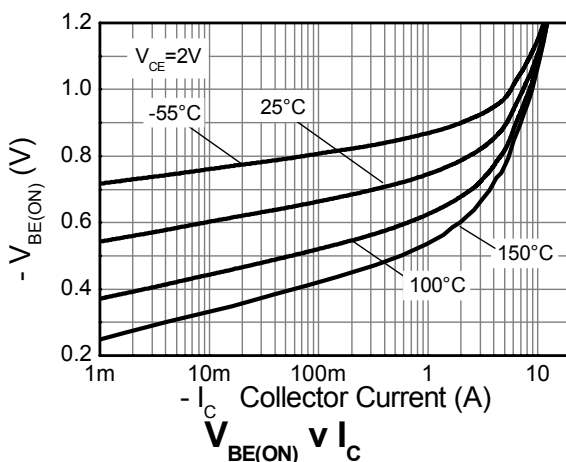
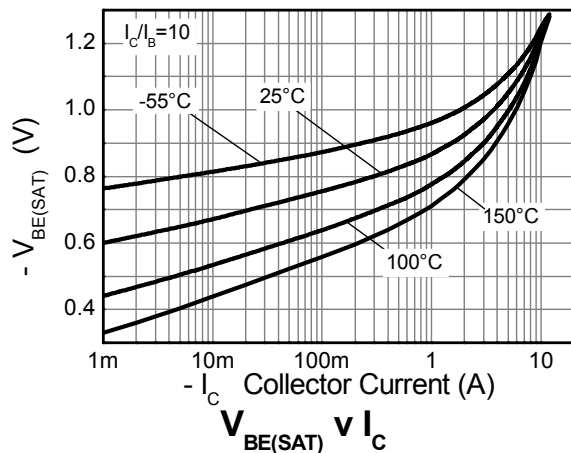
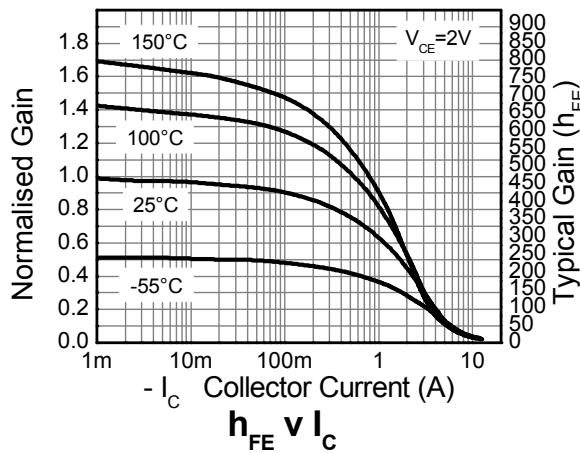
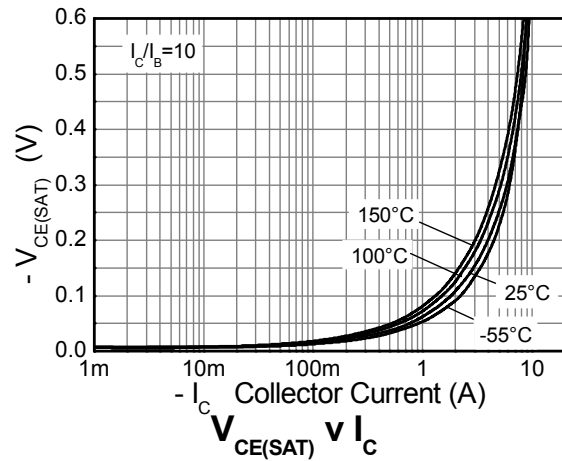
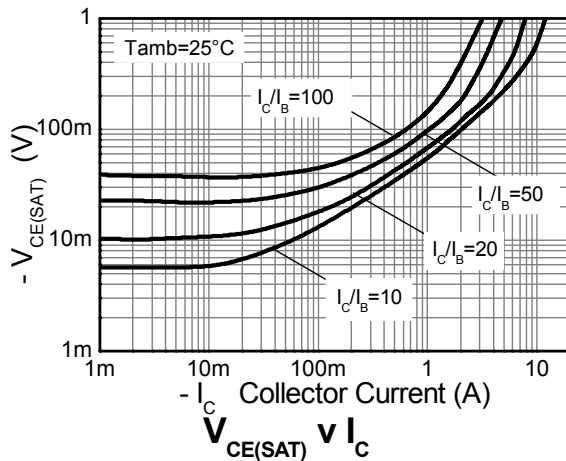
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BV_{CBO}	-25	-55	—	V	$I_C = -100\mu\text{A}, I_E = 0$
Collector-Emitter Breakdown Voltage (Note 12)	BV_{CEO}	-20	-45	—	V	$I_C = -10\text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	BV_{EBO}	-7	-8.3	—	V	$I_E = -100\mu\text{A}, I_C = 0$
Collector Cutoff Current	I_{CBO}	—	< -1	-50	nA	$V_{CB} = -25\text{V}$
Collector Cutoff Current	I_{EBO}	—	< -1	-50	nA	$V_{CB} = -25\text{V}, T_A = +100^\circ\text{C}$
Collector Cutoff Current	I_{EBO}	—	< -1	-50	nA	$V_{EB} = -5.6\text{V}$
ON CHARACTERISTICS (Note 12)						
DC Current Gain	h_{FE}	300 170 65 —	450 300 100 15	900 — — —	—	$I_C = -10\text{mA}, V_{CE} = -2\text{V}$ $I_C = -1.0\text{A}, V_{CE} = -2\text{V}$ $I_C = -3.5\text{A}, V_{CE} = -2\text{V}$ $I_C = -10\text{A}, V_{CE} = -2\text{V}$
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	—	-55 -100 -185 -190	-65 -135 -280 -250	mV	$I_C = -1.0\text{A}, I_B = -100\text{mA}$ $I_C = -1.0\text{A}, I_B = -20\text{mA}$ $I_C = -2.0\text{A}, I_B = -40\text{mA}$ $I_C = -3.5\text{A}, I_B = -175\text{mA}$
Base-Emitter Saturation Voltage	$V_{BE(sat)}$	—	-925	-1000	mV	$I_C = -3.5\text{A}, I_B = -175\text{mA}$
Base-Emitter Turn-On Voltage	$V_{BE(on)}$	—	-835	-900	mV	$I_C = -3.5\text{A}, V_{CE} = -2\text{V}$
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	C_{obo}	—	21	30	pF	$V_{CB} = -10\text{V}, f = 1.0\text{MHz}$
Current Gain-Bandwidth Product	f_T	—	290	—	MHz	$V_{CE} = -10\text{V}, I_C = -50\text{mA}, f = 100\text{MHz}$
Delay Time	t_d	—	56	—	ns	$V_{CC} = -10\text{V}, I_C = -1\text{A},$ $I_{B1} = -I_{B2} = -10\text{mA}$
Rise Time	t_r	—	68	—	ns	
Storage Time	t_s	—	158	—	ns	
Fall Time	t_f	—	59	—	ns	

Notes: 12. Measured under pulsed conditions. Pulse width $\leq 300\mu\text{s}$. Duty cycle $\leq 2\%$.

Typical Electrical Characteristics – Q1 (NPN Transistor) (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

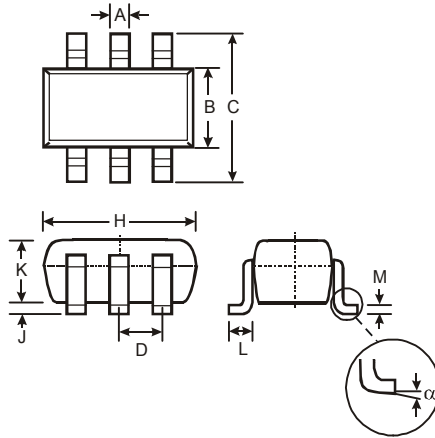


Typical Electrical Characteristics – Q2 (PNP Transistor) (@T_A = +25°C, unless otherwise specified.)



Package Outline Dimensions

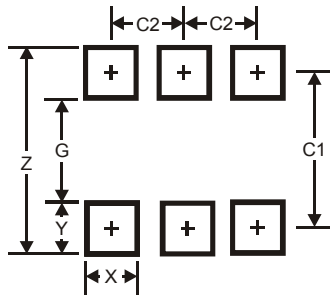
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



SOT26			
Dim	Min	Max	Typ
A	0.35	0.50	0.38
B	1.50	1.70	1.60
C	2.70	3.00	2.80
D	—	—	0.95
H	2.90	3.10	3.00
J	0.013	0.10	0.05
K	1.00	1.30	1.10
L	0.35	0.55	0.40
M	0.10	0.20	0.15
α	0°	8°	—
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
Z	3.20
G	1.60
X	0.55
Y	0.80
C1	2.40
C2	0.95

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